

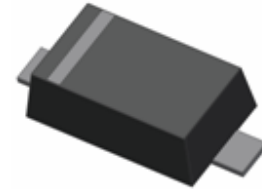
200mW SOD-523 SURFACE MOUNT

Very Small Outline Flat Lead Plastic Package

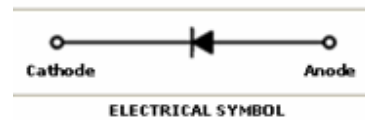
General Purpose Application

High Speed Switching Diode

Green Product



SOD-523 Flat Lead



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
P_D	Power Dissipation	200	mW
T_{STG}	Storage Temperature Range	-55 to +125	$^\circ\text{C}$
T_J	Operating Junction Temperature	+125	$^\circ\text{C}$
V_{RSM}	Non-Repetitive Peak Reverse Voltage	100	V
I_{FSM}	Peak Forward Surge Current (Pulse Width=1s)	500	mA
I_{FM}	Forward Current	200	mA

These ratings are limiting values above which the serviceability of the diode may be impaired.

Specification Features:

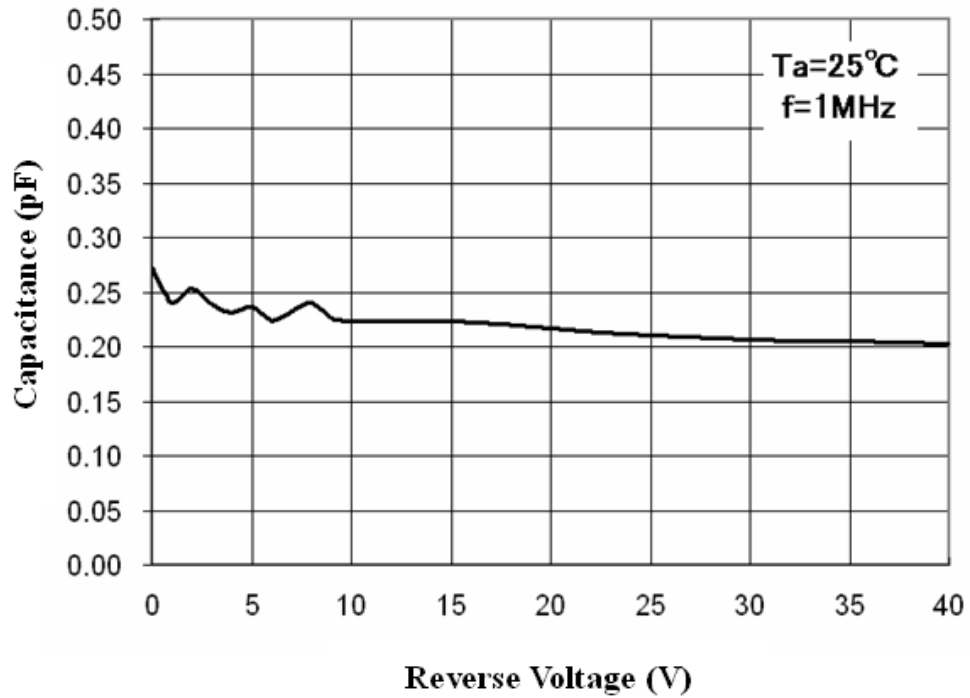
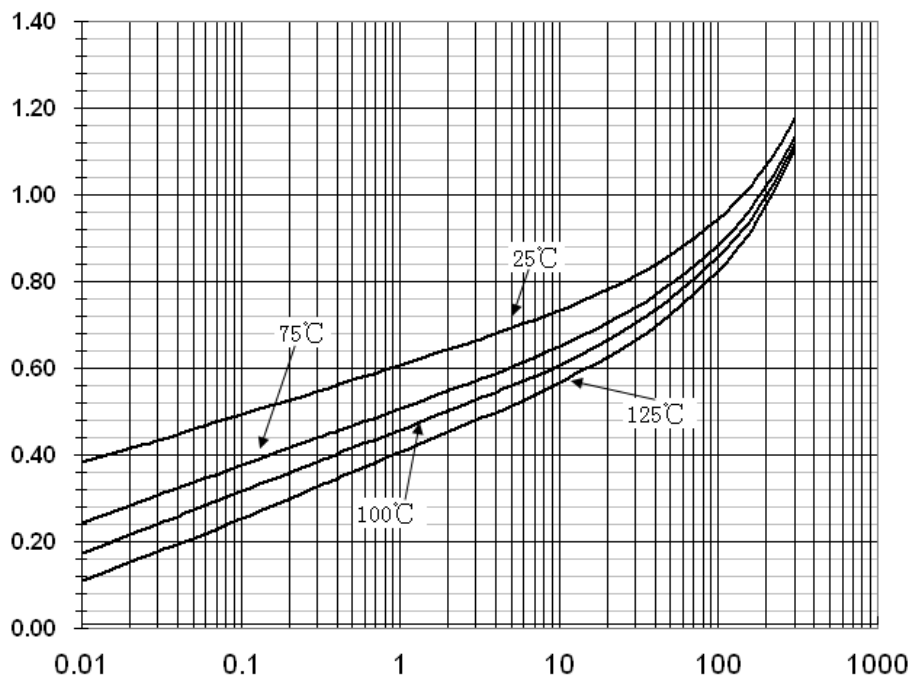
- Fast Switching Device ($T_{RR} < 4.0$ nS)
- High Speed Switching Diodes
- Extremely Small SOD-523 Package
- Flat Lead SOD-523 Small Outline Plastic Package
- Surface Device Type Mounting
- RoHS Compliant
- Green EMC
- Matte Tin(Sn) Lead Finish
- Band Indicates Cathode

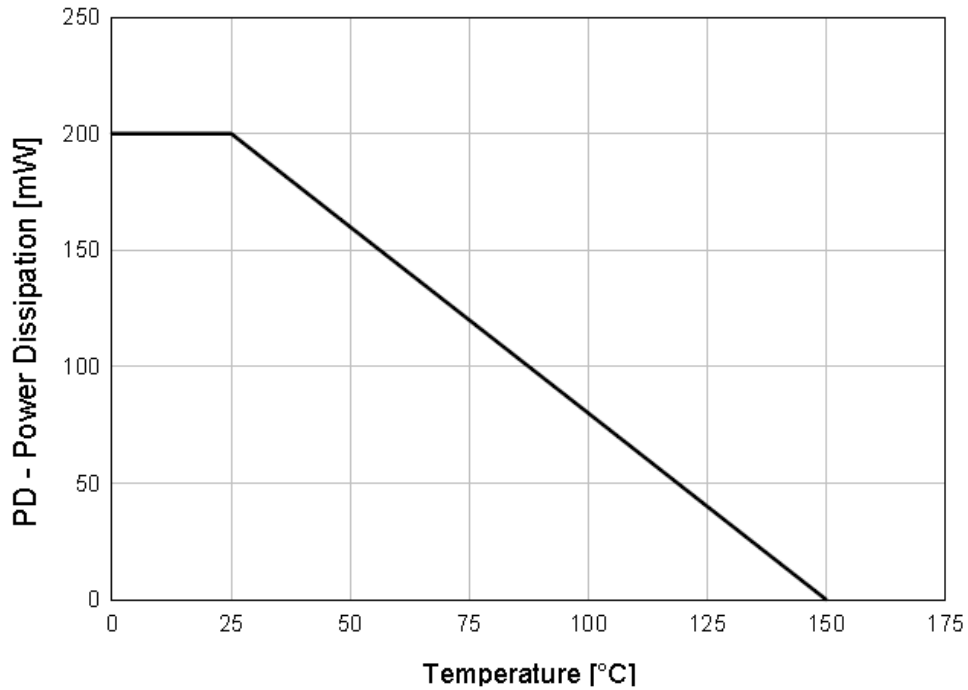
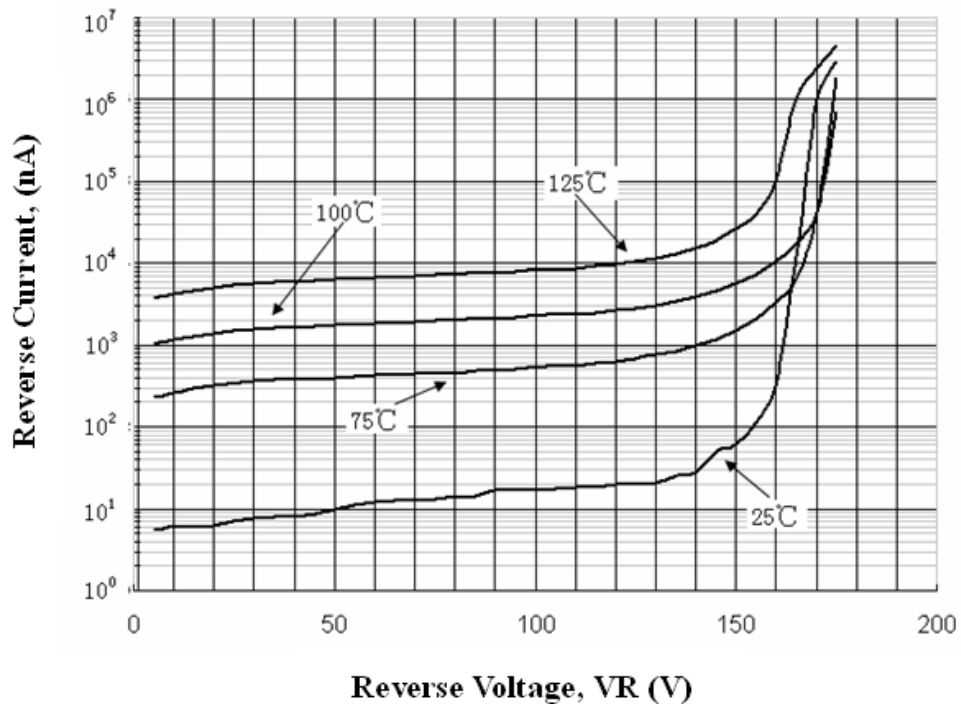
DEVICE MARKING CODE:

Device Type	Device Marking
1SS422	E5

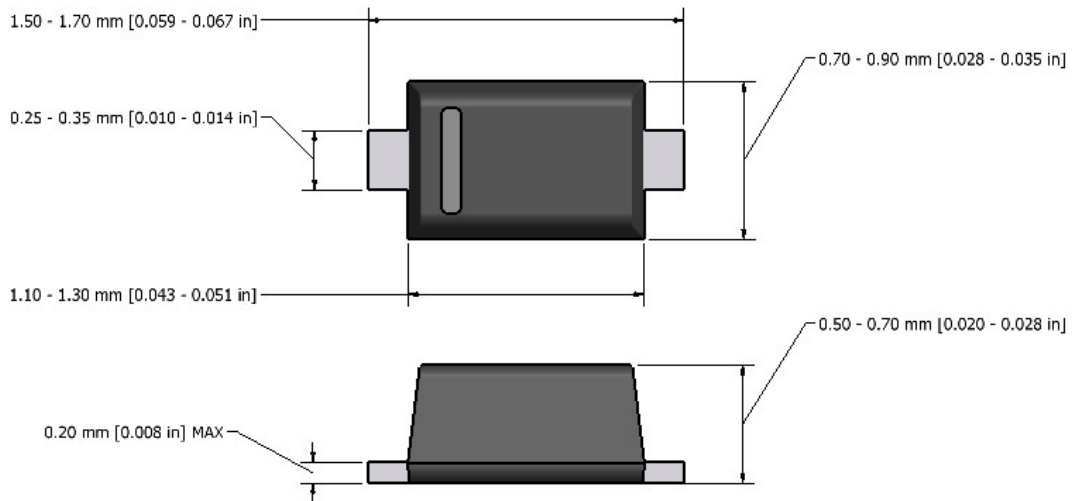
Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Limits		Unit
			Min	Max	
B_V	Breakdown Voltage	$I_R = 100\mu\text{A}$	100		Volts
I_R	Reverse Leakage Current	$V_R = 85\text{V}$		100	nA
V_F	Forward Voltage	$I_F = 150\text{mA}$		1.2	Volts
T_{RR}	Reverse Recovery Time	$I_F = 10\text{mA}$ $V_R = 6\text{V}$ $R_L = 100\Omega$		4	nS
C	Capacitance	$V_R = 0.5\text{V}$, $f = 1\text{MHz}$		4	pF

Typical Performance Characteristics
Total Capacitance

Forward Voltage vs Ambient Temperature


Power Derating Curve

Reverse Current vs Reverse Voltage


Flat Lead SOD-523 Package Outline



Note: Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

NOTICE

The information presented in this document is for reference only. Tak Cheong reserves the right to make changes without notice for the specification of the products displayed herein.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Tak Cheong Semiconductor Co., Ltd., or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

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